

Jennie S. Hwang, Ph.D., D.Sc.  
Phone: 216-577-3284; 914-764-3161  
[Jennie.hwang@h-techgroup.com](mailto:Jennie.hwang@h-techgroup.com)  
[www.JennieHwang.com](http://www.JennieHwang.com)

---

## *News Release*

**Dr. Jennie S. Hwang will deliver a professional development course on “*Preventing Manufacturing Defects and Product Failure*” at the virtual SMTAI conference on October 5 (11:30 a.m.–3:00 p.m.).**

**Further information:**

**<https://smta.org/events/EventDetails.aspx?id=1408042&group=>**

**She will also deliver two courses at the virtual IMAPS International Microelectronics and Packaging Symposium on October 7 (3:00–5:00 p.m.) and October 8 (1:00–3:00 p.m.) on “*Packaging/Board Integrity and Solder Joint Reliability*” and “*Prevent Product Failure: Tin Whisker and Intermetallic Compounds*,” respectively.**

**Further information:**

**[https://imaps.org/symposium\\_pdcs.php#a7](https://imaps.org/symposium_pdcs.php#a7)**

**[https://imaps.org/symposium\\_pdcs.php#b8](https://imaps.org/symposium_pdcs.php#b8)  
[bschieman@imaps.org](mailto:bschieman@imaps.org)**

###

*H-Technologies Group*  
[Office@H-TechGroup.com](mailto:Office@H-TechGroup.com)